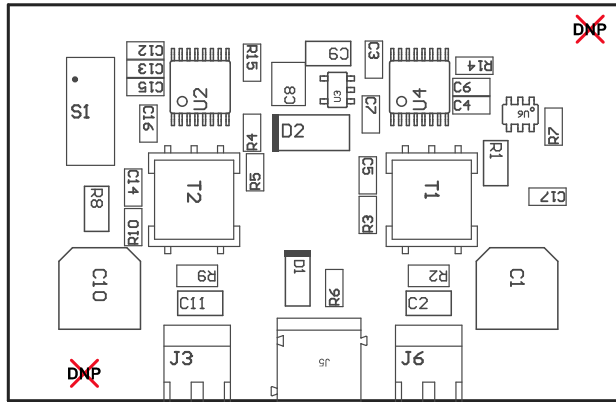
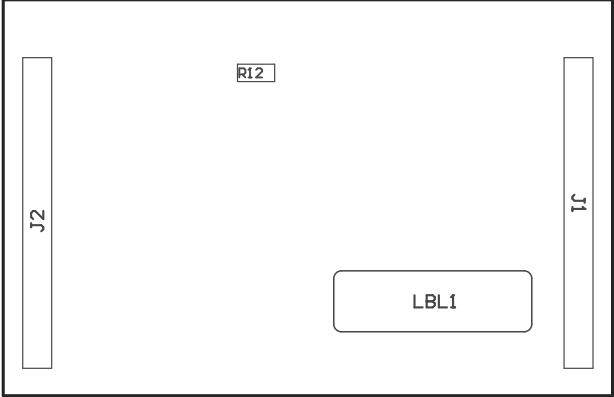


~~DNP~~



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01424	REV: E1	SVN REV: Not In VersionControl
	TID #: 01424		
PLOT NAME = Top Assembly Drawing	GENERATED : 3/20/2017 4:44:44 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01424	REV: E1	SVN REV: Not In VersionControl
	TID #: 01424		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/20/2017 4:44:46 PM		TEXAS INSTRUMENTS

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